

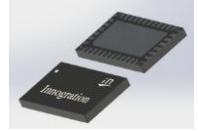


## 7W,C band 28V Plastic RF LDMOS Transistor

**ITEH58007C6**

### Description

The ITEH58007C6 is a 7-watt, highly rugged, LDMOS transistor, designed for any general applications at frequencies 4.8 to 6GHz, in 10\*6mm QFN plastic package, supporting surface mounted on PCB through high density grounding vias.



- Typical 4.9-6.2GHz Class AB RF Performance (On Innegration fixture with device soldered).

**$V_{DS} = 28V$ ,  $I_{DQ} = 65mA$**

Freq (MHz)	P1dB (dBm)	P1dB (W)	P1dB Eff (%)	P1dB Gain(dB)	P3dB (dBm)	P3dB (W)	P3dB Eff (%)
4900	38.71	7.4	33.9	9.43	39.49	8.9	35.8
5000	38.71	7.4	34.9	10.16	39.51	8.9	36.6
5100	38.51	7.1	34.5	10.98	39.41	8.7	36.8
5200	38.53	7.1	36.3	11.54	39.51	8.9	38.7
5300	38.59	7.2	37.9	11.92	39.61	9.2	40.6
5400	38.37	6.9	37.2	12.15	39.51	8.9	40.5
5500	38.49	7.1	38.9	11.64	39.67	9.3	42.2
5600	38.26	6.7	37.8	11.62	39.53	9.0	41.1
5700	38.1	6.5	36.7	10.59	39.41	8.7	40.2
5800	38.01	6.3	36.0	10.12	39.39	8.7	39.9
5900	37.9	6.2	34.8	10.05	39.35	8.6	38.9
6000	37.8	6.0	33.2	9.12	39.18	8.3	36.7
6100	37.86	6.1	33.5	8.42	39.28	8.5	37.3
6200	37.8	6.0	31.9	8.04	39.12	8.2	35.3

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- C band power amplifier
- 5G cellular power amplifier within 5-6GHz
- WIFI High power access point

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	$V_{DS}$	+65	Vdc
Gate--Source Voltage	$V_{GS}$	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+28	Vdc
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Case Operating Temperature	$T_c$	+150	°C
Operating Junction Temperature	$T_j$	+225	°C



**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_C = 85^{\circ}\text{C}$ , $T_J = 200^{\circ}\text{C}$ , DC test	$R_{\theta JC}$	4.1	$^{\circ}\text{C/W}$

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

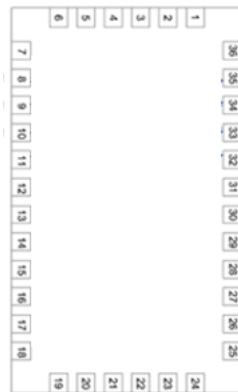
**Table 4. Electrical Characteristics** ( $T_A = 25^{\circ}\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics</b>					
Drain-Source Voltage $V_{GS} = 0$ , $I_{DS} = 100\mu\text{A}$	$V_{(BR)DSS}$		65		V
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28\text{V}$ , $V_{GS} = 0\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate--Source Leakage Current ( $V_{GS} = 11\text{V}$ , $V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	1	$\mu\text{A}$
Gate Threshold Voltage ( $V_{DS} = 28\text{V}$ , $I_D = 600\mu\text{A}$ )	$V_{GS(th)}$	—	2	—	V
Gate Quiescent Voltage ( $V_{DD} = 28\text{V}$ , $I_D = 60\text{mA}$ , Measured in Functional Test)	$V_{GS(Q)}$	—	2.7	—	V

**Load Mismatch (In Innogrator Test Fixture, 50 ohm system):**  $V_{DD} = 28\text{Vdc}$ ,  $I_{DQ} = 60\text{mA}$ ,  $f = 5000\text{MHz}$

VSWR 10:1 at 12W pulse CW Output Power	No Device Degradation
----------------------------------------	-----------------------

**Figure 1: Pin Definition (Top View)**



Pin No.	Symbol	Description
8,9,10,11	Vgs/RF In	Vgs and RF input
32,33,34,35	Vds/RF out	Vds and RF output
2,5,7,12,13,18,20,23,25,30,31,36	GND	DC/RF Ground
Others	NC	No connection
Package Base	GND	DC/RF Ground.

**Reference Circuit of Test Fixture Assembly Diagram**  
**4900-6200MHz RO4350B 20mils**

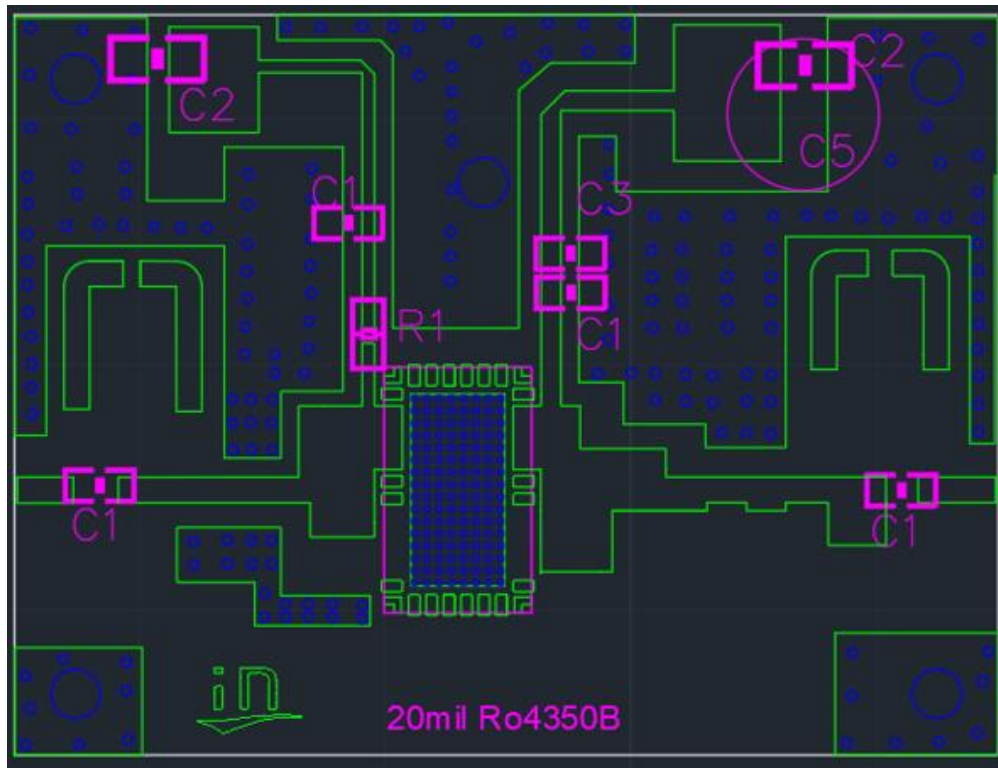


Figure 2. Test Circuit Component Layout

Table 5. Test Circuit Component Designations and Values

Component	Value	Quantity
C1	3.9pF	4
C2	10uF	2
R1	10 ohm	1
C5	470uF	1
C3	1uF	1



## TYPICAL CHARACTERISTICS

Figure 3. Power Gain and Drain Efficiency as function of Power Out at  $I_{dq}=6mA$

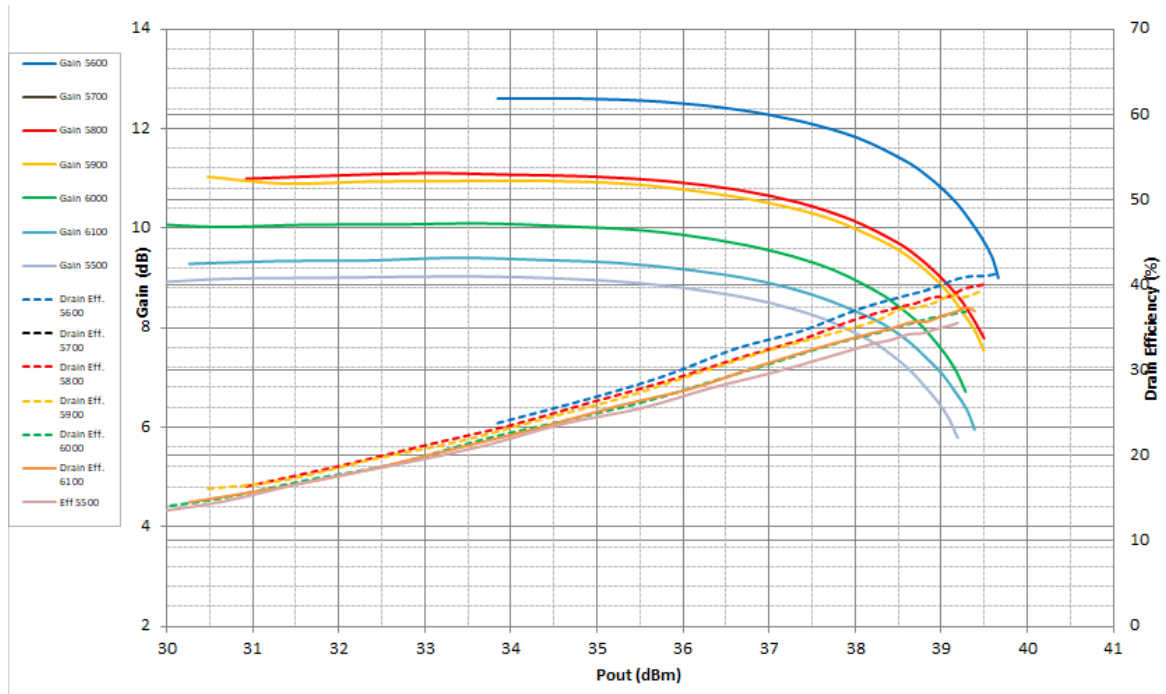
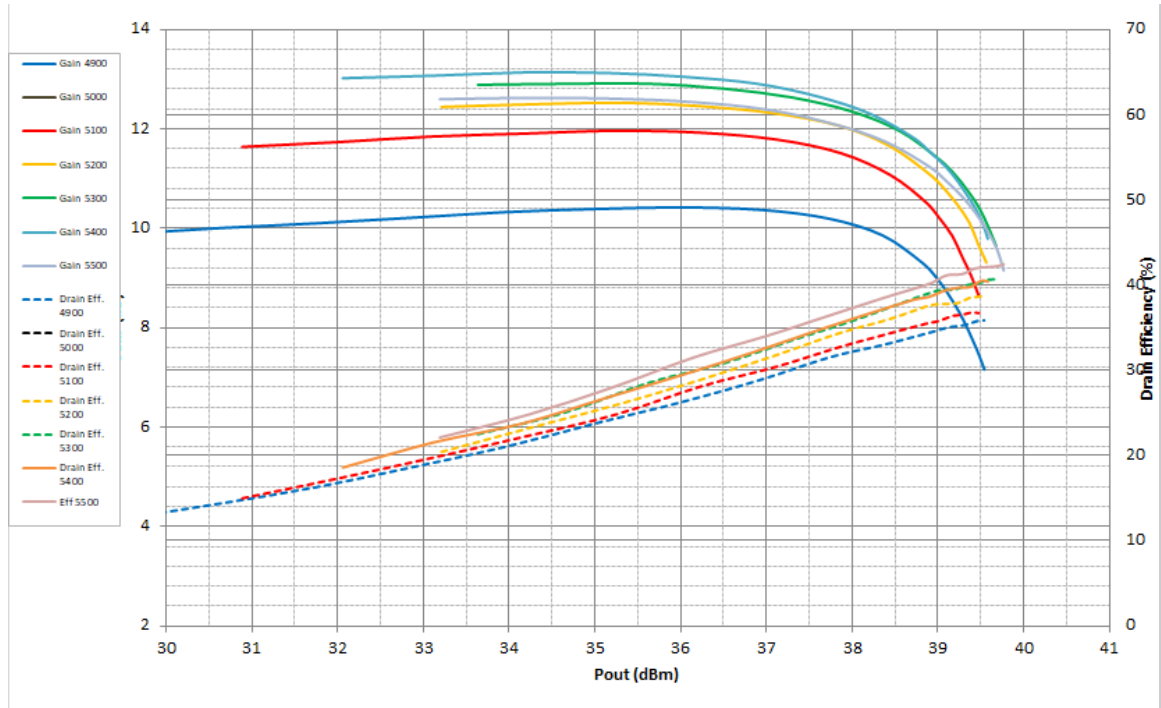
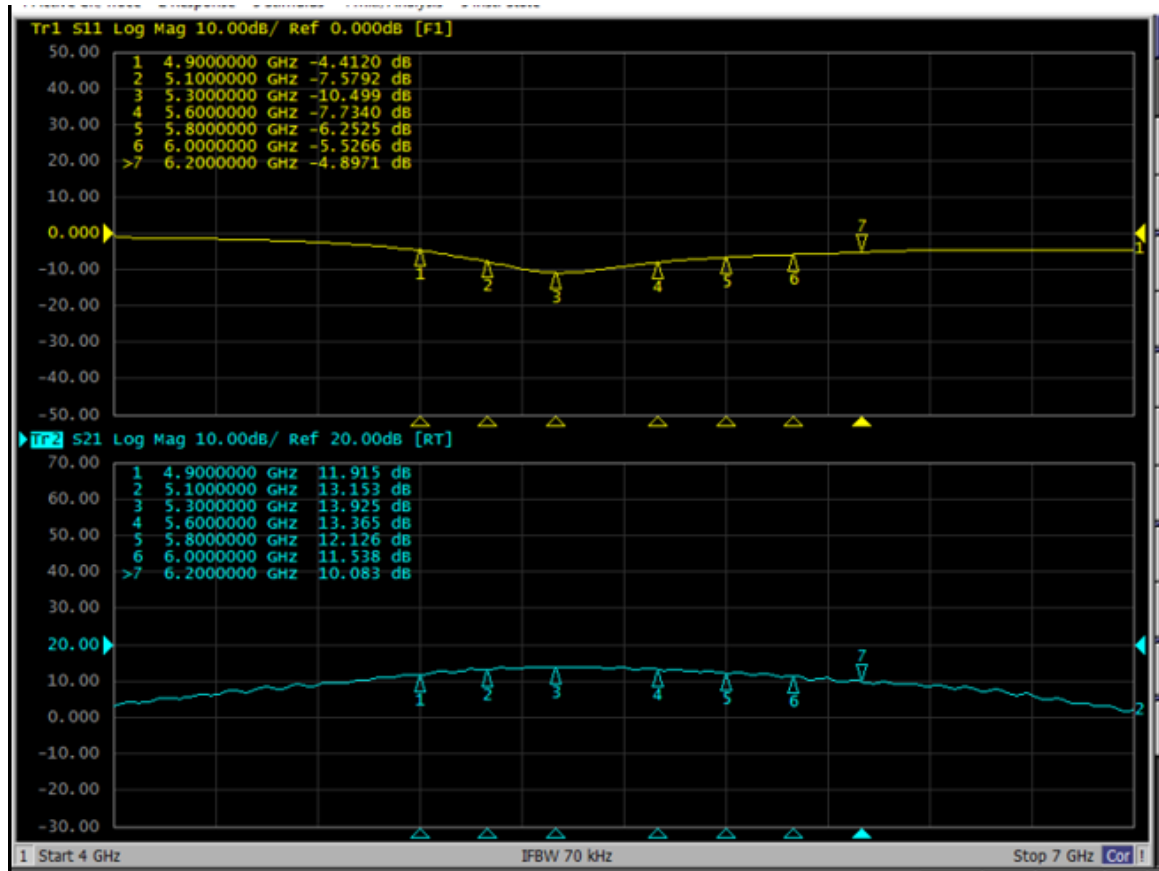




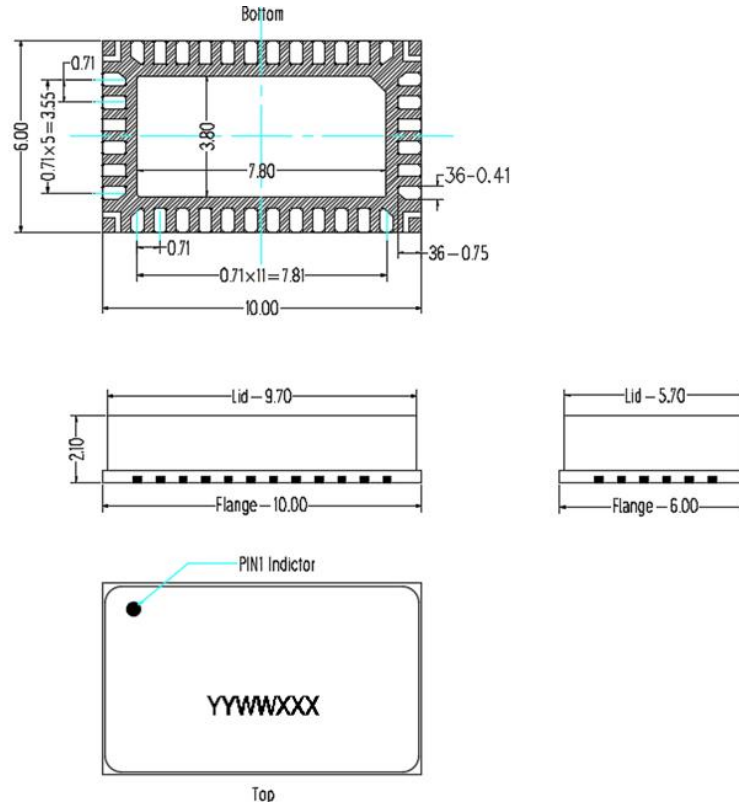
Figure 4. Network analyzer output S11/S21





## Package Dimensions

### 10\*6 Plastic Package



#### Notes:

1. All dimensions are in mm; and the tolerances unless specified are  $\pm 0.2$ mm.

## Revision history

Table 7. Document revision history

Date	Revision	Datasheet Status
2022/8/15	Rev 1.0	Preliminary Datasheet
2022/12/9	Rev 1.1	Update on Pin Definition
2024/12/5	Rev 1.2	Use 5.1-5.9G as carrier application
2025/7/18	Rev 1.3	Change the carrier application to 4.9-6.2G

### Application data based on ZXY-22-32/25-10

## Disclaimers

Specifications are subject to change without notice. Innegration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innegration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innegration. Innegration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innegration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innegration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innegration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innegration and authorized distributors

Copyright © by Innegration (Suzhou) Co.,Ltd.